



Plasma and Fine Bubbles

Guest Editors:

Prof. Dr. Jong-Shinn Wu

Department of Mechanical
Engineering, National Yang Ming
Chiao Tung University, 1001
University Road, Hsinchu 30010,
Taiwan

Dr. Chia-Hung Dylan Tsai

Department of Mechanical
Engineering, National Yang Ming
Chiao Tung University, 1001
University Road, Hsinchu 30010,
Taiwan

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Message from the Guest Editors

The combination of plasma and fine bubbles is an emerging field that incorporates plasma science in micro and nano scales. On one hand, plasma is an enabling technology, and has played a vital role in different fields, particularly in modern medicines. On the other hand, fine bubbles are bubbles in micro and nano scales and have remarkable physical properties, such as large interfacial area and high gas pressure. The combination of these two enables major advances to be made in both fields or synthesized into a new technological field; it not only tremendously improves the effect of plasma treatment, but also considerably increases the functionality of fine bubbles with reactive species generated in plasma. In this Special Issue, we would like to assemble cutting-edge advances in plasma and fine bubbles for reporting recent achievements, as well as exploring potentials in the uprising brand new field. Researchers in different perspectives in the field are welcome to submit their results to this issue.





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Editor-in-Chief

Prof. Dr. Ai-Qun Liu

1. Department of Electrical and Electronic Engineering, The Hong Kong Polytechnic University, Hong Kong, China
2. School of Electrical and Electronic Engineering, Nanyang Technological University, Singapore 639798, Singapore

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Micromachines Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

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